Low Noise Transistor

NPN Silicon

Features

 These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--------------------------------|------------------|-------|------|
| Collector - Emitter Voltage | V_{CEO} | 60 | Vdc |
| Collector - Base Voltage | V _{CBO} | 60 | Vdc |
| Emitter - Base Voltage | V _{EBO} | 6.0 | Vdc |
| Collector Current - Continuous | Ic | 100 | mAdc |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|--|-----------------------------------|-------------|-------------|
| Total Device Dissipation FR-5 Board, (Note 1) T _A = 25°C Derate above 25°C | P _D | 225 1.8 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 556 | °C/W |
| Total Device Dissipation Alumina Substrate, (Note 2) T _A = 25°C Derate above 25°C | P _D | 300 2.4 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 417 | °C/W |
| Junction and Storage Temperature | T _J , T _{stg} | -55 to +150 | °C |

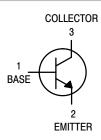
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. $FR-5 = 1.0 \times 0.75 \times 0.062$ in.
- 2. Alumina = $0.4 \times 0.3 \times 0.024$ in. 99.5% alumina.



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SOT-23 (TO-236) CASE 318 STYLE 6

MARKING DIAGRAM



1U = Device Code

M = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

| D | evice | Package | Shipping [†] |
|-----|-----------|---------------------|-----------------------|
| ММВ | T2484LT1G | SOT-23 (Pb-Free) | 3,000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

| Characteristic | Symbol | Min | Max | Unit |
|---|-----------------------|----------|----------|--------------|
| OFF CHARACTERISTICS | | | • | • |
| Collector – Emitter Breakdown Voltage ($I_C = 10 \text{ mAdc}$, $I_B = 0$) | V _{(BR)CEO} | 60 | _ | Vdc |
| Collector – Base Breakdown Voltage ($I_C = 10 \mu Adc, I_E = 0$) | V _(BR) CBO | 60 | - | Vdc |
| Emitter – Base Breakdown Voltage ($I_E = 10 \mu Adc, I_C = 0$) | V _{(BR)EBO} | 5.0 | - | Vdc |
| Collector Cutoff Current $(V_{CB} = 45 \text{ Vdc}, I_E = 0)$ $(V_{CB} = 45 \text{ Vdc}, I_E = 0, T_A = 150^{\circ}\text{C})$ | I _{CBO} | - - | 10 10 | nAdc μAdc |
| Emitter Cutoff Current $(V_{EB} = 5.0 \text{ Vdc}, I_C = 0)$ | I _{EBO} | - | 10 | nAdc |
| ON CHARACTERISTICS | | | | • |
| DC Current Gain $ \begin{aligned} \text{(I}_{\text{C}} &= 1.0 \text{ mAdc, V}_{\text{CE}} = 5.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} &= 10 \text{ mAdc, V}_{\text{CE}} = 5.0 \text{ Vdc)} \end{aligned} $ | h _{FE} | 250 - | _ 800 | - |
| Collector – Emitter Saturation Voltage (I _C = 1.0 mAdc, I _B = 0.1 mAdc) | V _{CE(sat)} | - | 0.35 | Vdc |
| Base – Emitter On Voltage (I _C = 1.0 mAdc, V _{CE} = 5.0 Vdc) | V _{BE(on)} | - | 0.95 | Vdc |
| SMALL-SIGNAL CHARACTERISTICS | | | | • |
| Output Capacitance ($V_{CB} = 5.0 \text{ Vdc}$, $I_E = 0$, $f = 1.0 \text{ MHz}$) | C _{obo} | - | 6.0 | pF |
| Input Capacitance (V _{EB} = 0.5 Vdc, I _C = 0, f = 1.0 MHz) | C _{ibo} | - | 6.0 | pF |
| Noise Figure (I _C = 10 μ Adc, V _{CE} = 5.0 Vdc, R _S = 10 μ Q, f = 1.0 kHz, BW = 200 Hz) | NF | - | 3.0 | dB |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

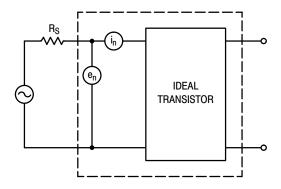
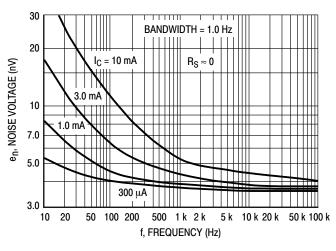


Figure 1. Transistor Noise Model

NOISE CHARACTERISTICS

 $(V_{CE} = 5.0 \text{ Vdc}, T_A = 25^{\circ}C)$

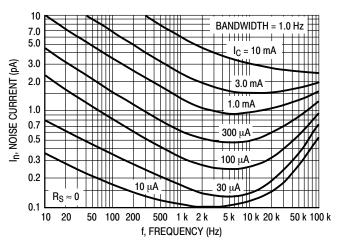
NOISE VOLTAGE



BANDWIDTH = 1.0 Hz 20 $R_S\approx 0\,$ en, NOISE VOLTAGE (nV) f = 10 Hz 10 100 Hz 7.0 1.0 kHz 5.0 3.0 0.02 0.01 0.05 0.1 0.2 0.5 5.0 10 IC, COLLECTOR CURRENT (mA)

Figure 2. Effects of Frequency

Figure 3. Effects of Collector Current



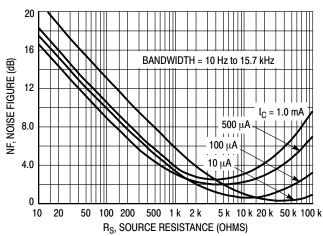
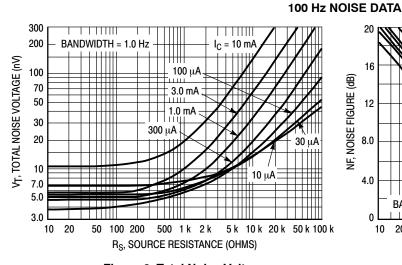


Figure 4. Noise Current

Figure 5. Wideband Noise Figure



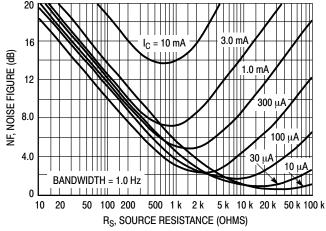


Figure 6. Total Noise Voltage

Figure 7. Noise Figure

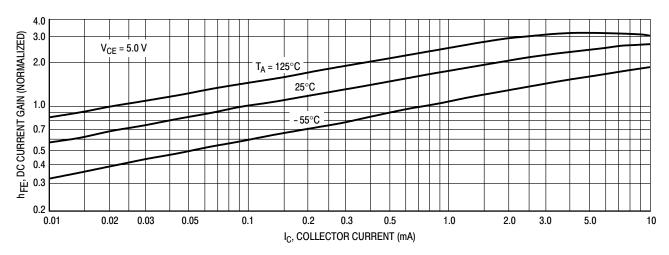


Figure 8. DC Current Gain

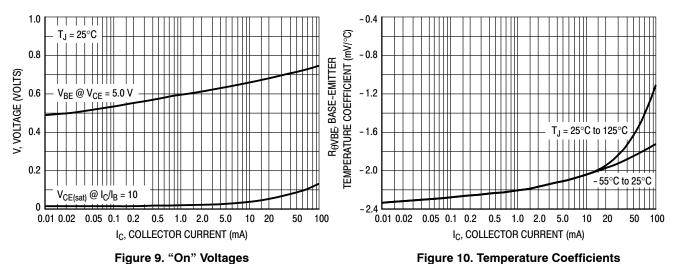


Figure 9. "On" Voltages

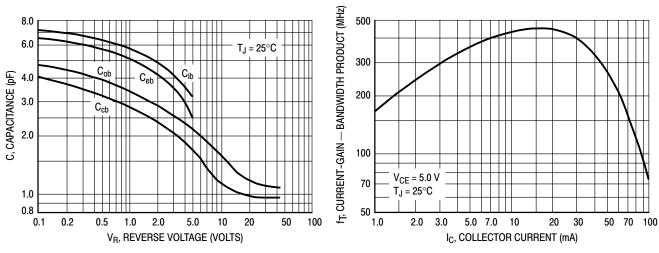


Figure 11. Capacitance

Figure 12. Current-Gain — Bandwidth Product



SOT-23 (TO-236) CASE 318-08 **ISSUE AS**

DATE 30 JAN 2018

SCALE 4:1 D - 3X b

TOP VIEW







RECOMMENDED SOLDERING FOOTPRINT



DIMENSIONS: MILLIMETERS

NOTES:

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH.
 MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH,

| | PROT | RUSIONS, OR GATE BURRS. | |
|--|------|-------------------------|--|
|--|------|-------------------------|--|

| | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |
| Α | 0.89 | 1.00 | 1.11 | 0.035 | 0.039 | 0.044 |
| A1 | 0.01 | 0.06 | 0.10 | 0.000 | 0.002 | 0.004 |
| b | 0.37 | 0.44 | 0.50 | 0.015 | 0.017 | 0.020 |
| С | 0.08 | 0.14 | 0.20 | 0.003 | 0.006 | 0.008 |
| D | 2.80 | 2.90 | 3.04 | 0.110 | 0.114 | 0.120 |
| E | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| е | 1.78 | 1.90 | 2.04 | 0.070 | 0.075 | 0.080 |
| L | 0.30 | 0.43 | 0.55 | 0.012 | 0.017 | 0.022 |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.027 |
| HE | 2.10 | 2.40 | 2.64 | 0.083 | 0.094 | 0.104 |
| Т | 0° | | 10° | 0° | | 10° |

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

| STYLE 1 THRU 5: CANCELLED | STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR | STYLE 7: PIN 1. EMITTER 2. BASE 3. COLLECTOR | STYLE 8: PIN 1. ANODE 2. NO CONNECTION 3. CATHODE |
|------------------------------|---|---|--|
| OT (1 F O | | | |

SOT-23 (TO-236)

| STYLE 9: | STYLE 10: | STYLE 11: | STYLE 12: | STYLE 13: | STYLE 14: |
|---------------------------|--------------------------|---------------------------------|---------------------------|---------------|-------------------------|
| PIN 1. ANODE | PIN 1. DRAIN | PIN 1. ANODE | PIN 1. CATHODE | PIN 1. SOURCE | PIN 1. CATHODE |
| ANODE | SOURCE | CATHODE | CATHODE | 2. DRAIN | 2. GATE |
| CATHODE | 3. GATE | CATHODE-ANODE | ANODE | 3. GATE | ANODE |

| STYLE 15: | STYLE 16: | STYLE 17: | STYLE 18: | STYLE 19: | STYLE 20: |
|---------------------------|---------------------------|---------------------------|---------------------------|--------------------------------|-------------------------|
| PIN 1. GATE | PIN 1. ANODE | PIN 1. NO CONNECTION | PIN 1. NO CONNECTION | PIN 1. CATHODE | PIN 1. CATHODE |
| CATHODE | CATHODE | 2. ANODE | CATHODE | 2. ANODE | ANODE |
| ANODE | CATHODE | CATHODE | ANODE | CATHODE-ANOD | E 3. GATE |

| STYLE 21: | STYLE 22: | STYLE 23: | STYLE 24: | STYLE 25: | STYLE 26: |
|--------------------------|--------------------------|--------------|-------------|--------------|---------------------------------|
| PIN 1. GATE | PIN 1. RETURN | PIN 1. ANODE | PIN 1. GATE | PIN 1. ANODE | PIN 1. CATHODE |
| SOURCE | OUTPUT | 2. ANODE | 2. DRAIN | 2. CATHODE | 2. ANODE |
| 3 DRAIN | 3 INPLIT | 3 CATHODE | 3. SOURCE | 3. GATE | NO CONNECTION |

| STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE | STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE | |
|---|---|--|
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